

IFW



Attorney Docket 0553-0166.01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of )  
)  
Yamazaki et al. )  
)  
Serial No.: 10/629,069 )  
)  
Filed: July 29, 2003 )  
)  
For: Wiring Material And A )  
Semiconductor Device Having A )  
Wiring Using the Material, And The )  
Manufacturing Method Thereof )  
)  
Art Unit: 2826 )  
)  
Examiner: Fetsum Abraham )

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Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 6/14/06  
Signature Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT E**

Sir:

In response to the Office Action mailed March 14, 2006, please amend the above-identified application as follows: